

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: **Johnny Ch ng, et al.**

Docket No.: **TI-31614.1A**

Serial No.: **TBD**

Examiner: **TBD**

Filed: **Herewith**

Art Unit: **TBD**

For: **BGA Substrate Via Structure**

Conf. No.: **TBD**

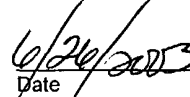
**TRANSMITTAL OF FORMAL DRAWINGS**

Commissioner For Patents  
Attn: Official Drafts Person  
Alexandria, VA 22313-1450

**MAILING CERTIFICATE UNDER 37 C.F.R. § 1.8(a)**

I hereby certify that the above correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Commissioner For Patents, Alexandria, VA 22313-1450.

  
Elizabeth Austin

  
Date

Dear Sir:

Submitted herewith are 3 sheets of formal drawings.

The enclosed drawings are being provided in a timely manner therefore no additional fee is required.

No fee is believed by Applicant to be due; however, the Commissioner is hereby authorized and requested to charge any necessary fee to the deposit account of Texas Instruments Incorporated, Account No. 20-0668.

Respectfully submitted,



Michael K. Skrehot  
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Reg. No.: 36,682

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